



YEA SHIN TECHNOLOGY CO., LTD

YS0854SCF

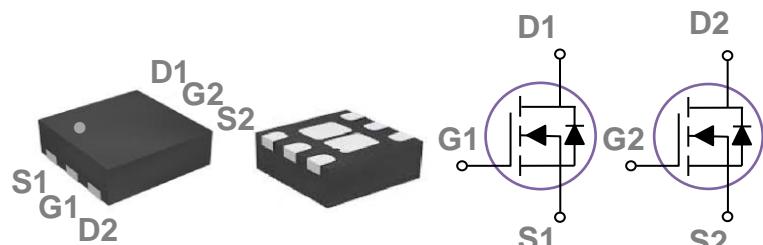
Dual N-Channel Enhancement MOSFET
VDS= 100V, ID= 1.2A



Features

- 100V, 1.2A, $R_{DS(ON)} = 390m\Omega$ @ $V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

DFN2X2 Dual 2EP Pin Configuration



Applications

- Networking
- Load Switch
- LED applications

Absolute Maximum Rating $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current – Continuous ($T_A=25^\circ C$)	1.2	A
	Drain Current – Continuous ($T_A=70^\circ C$)	0.96	A
I_{DM}	Drain Current – Pulsed ¹	4.8	A
P_D	Power Dissipation ($T_A=25^\circ C$)	1.25	W
	Power Dissipation – Derate above 25°C	0.01	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	100	°C /W

DEVICE CHARACTERISTICS

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Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	100	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	---	0.09	---	mV°C
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{DS}}=80\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-source On-Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=1\text{A}$	---	330	390	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=0.5\text{A}$	---	350	420	$\text{m}\Omega$
		$V_{\text{GS}}=4.0\text{V}, I_{\text{D}}=0.3\text{A}$	---	400	900	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\mu\text{A}$	1.2	1.8	2.5	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	-5	---	mV°C
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=1\text{A}$	---	2.3	---	S

Dynamic and Switching Characteristics

Q_g	Total Gate Charge ^{2,3}	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=1\text{A}$	---	9	18	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	2.3	4.6	
Q_{gd}	Gate-Drain Charge ^{2,3}		---	1.1	2.5	
$T_{\text{d(on)}}$	Turn-On Delay Time ^{2,3}	$V_{\text{DD}}=50\text{V}, V_{\text{GS}}=10\text{V}, R_{\text{G}}=3.3\Omega, I_{\text{D}}=1\text{A}$	---	5.2	10	ns
T_r	Rise Time ^{2,3}		---	6.8	12	
$T_{\text{d(off)}}$	Turn-On Delay Time ^{2,3}		---	14.5	28	
T_f	Fall Time ^{2,3}		---	2.1	5	
C_{iss}	Input Capacitance	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	345	670	pF
C_{oss}	Output Capacitance		---	9.3	19	
C_{rss}	Reverse Transfer Capacitance		---	4.3	9	
R_g	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, f=1\text{MHz}$	---	2.8	5.6	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	1.2	A
I_{SM}	Pulsed Source Current		---	---	2.4	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_s=1\text{A}, T_J=25^\circ\text{C}$	---	---	1	V

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

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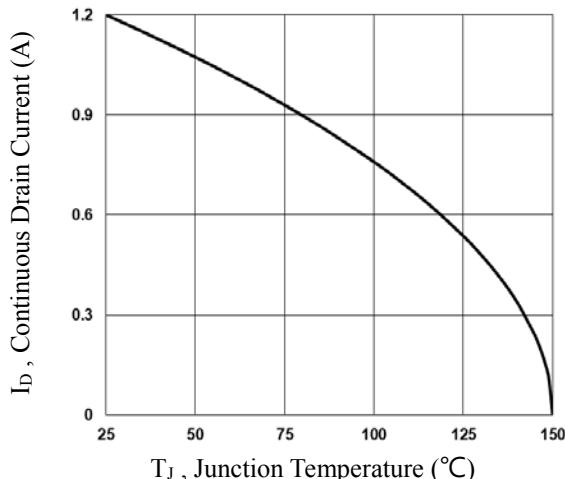


Fig.1 Continuous Drain Current vs. T_J

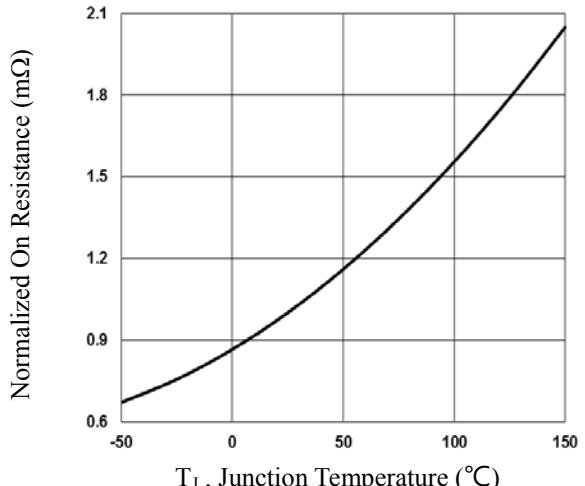


Fig.2 Normalized RD_{SON} vs. T_J

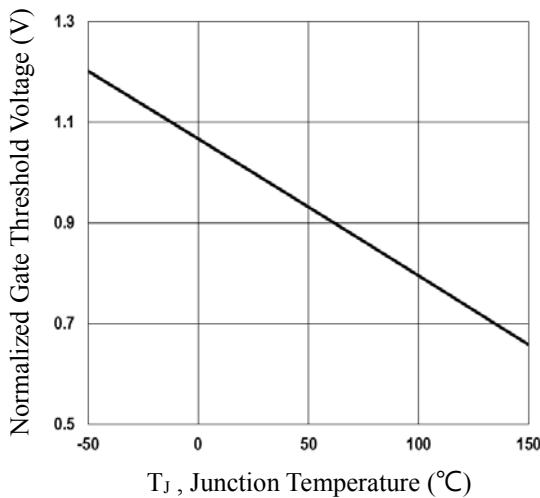


Fig.3 Normalized V_{th} vs. T_J

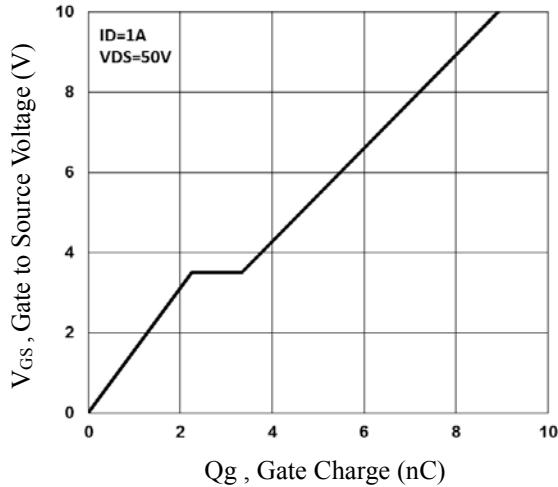


Fig.4 Gate Charge Waveform

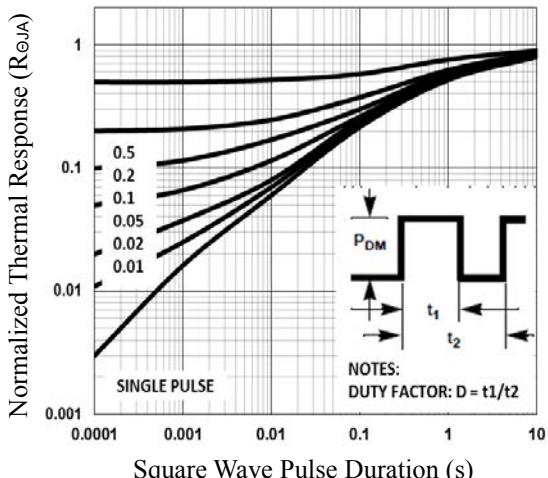


Fig.5 Normalized Transient Response

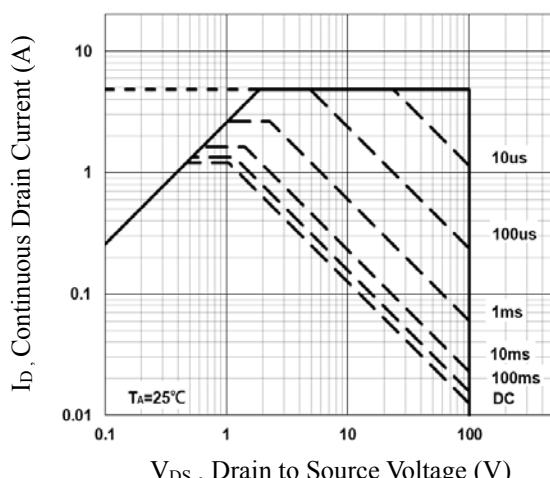


Fig.6 Maximum Safe Operation Area

DEVICE CHARACTERISTICS

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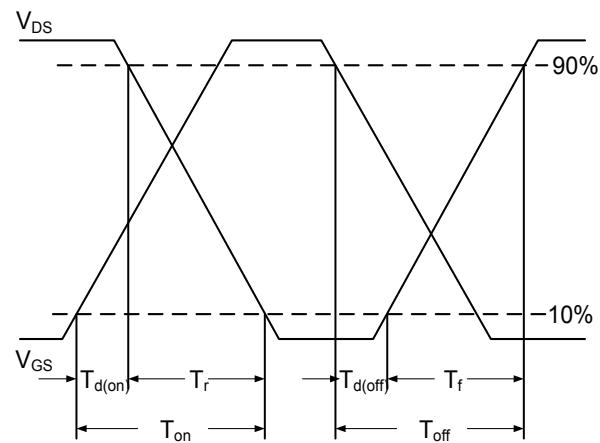


Fig.7 Switching Time Waveform

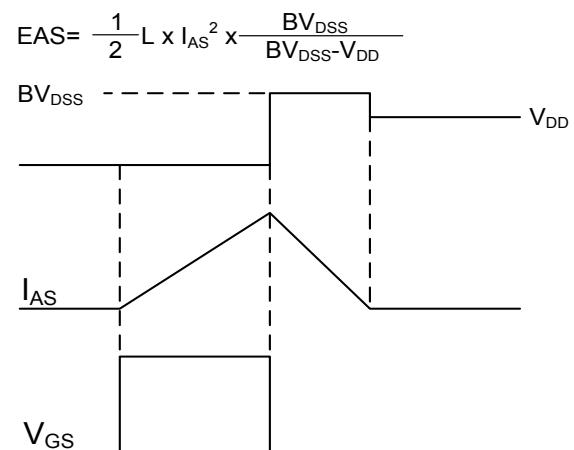
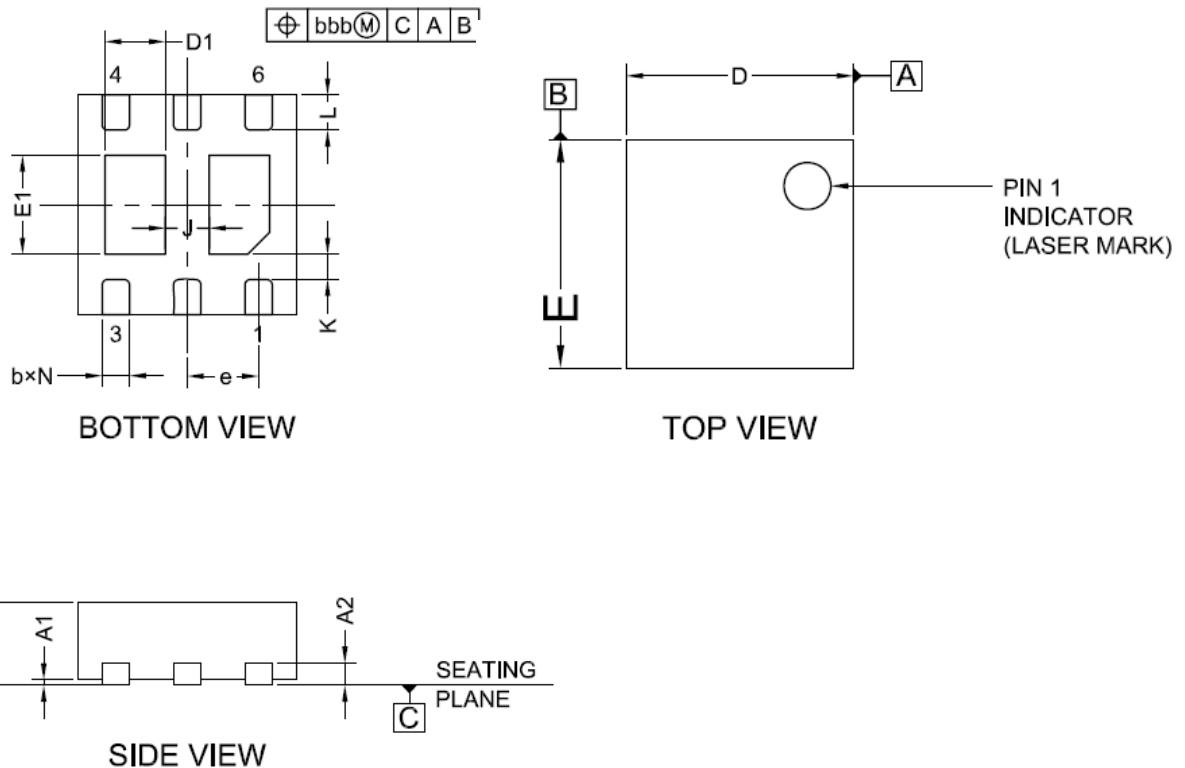


Fig.8 EAS Waveform

PACKAGE OUTLINE & DIMENSIONS

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DFN2X2 Dual 2EP PACKAGE INFORMATION



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2	0.203		
b	0.20	0.25	0.30
D	1.95	2.00	2.05
D1	0.50	0.55	0.60
E	1.95	2.00	2.05
E1	0.85	0.90	0.95
e	0.65BSC		
L	0.27	0.32	0.37
J	0.40BSC		
K	0.20MIN		
N		6	
aaa		0.08	
bbb		0.10	